

SANYO Semiconductors DATA SHEET

N-Channel Silicon MOSFET

FW812 — General-Purpose Switching Device Applications

Features

- · Low ON-resistance
- · 4V drive
- · Composite type with 2 MOSFETs contained in a single package, facilitating high-density mounting

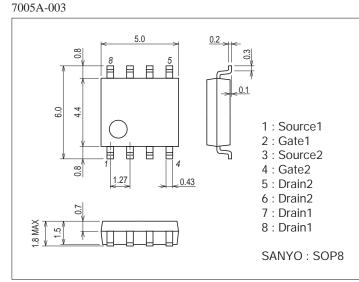
Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V _{DSS}		35	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		10	Α
Drain Current (PW=10s)	ID	Duty cycle≤1%	11.5	Α
Drain Current (PW≤10μs)	I _{DP}	Duty cycle≤1%	52	Α
Allowable Power Dissipation	PD	When mounted on ceramic substrate (2000mm²x0.8mm) 1unit, PW≤10s	2.3	W
Total Dissipation	PT	When mounted on ceramic substrate (2000mm ² ×0.8mm), PW≤10s	2.5	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Package Dimensions

unit: mm (typ)

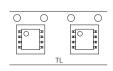


Product & Package Information

• Package : SOP8

JEITA, JEDEC : SC-87, SOT96
 Minimum Packing Quantity : 1,000 pcs./reel

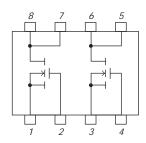
Packing Type : TL



Marking



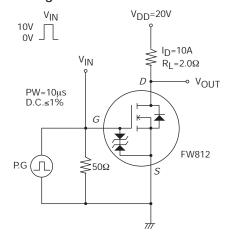
Electrical Connection

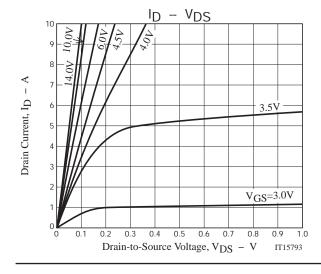


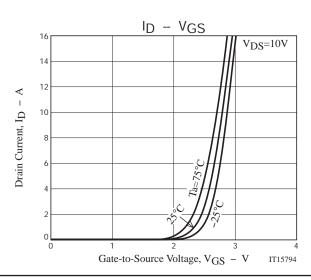
Electrical Characteristics at Ta=25°C

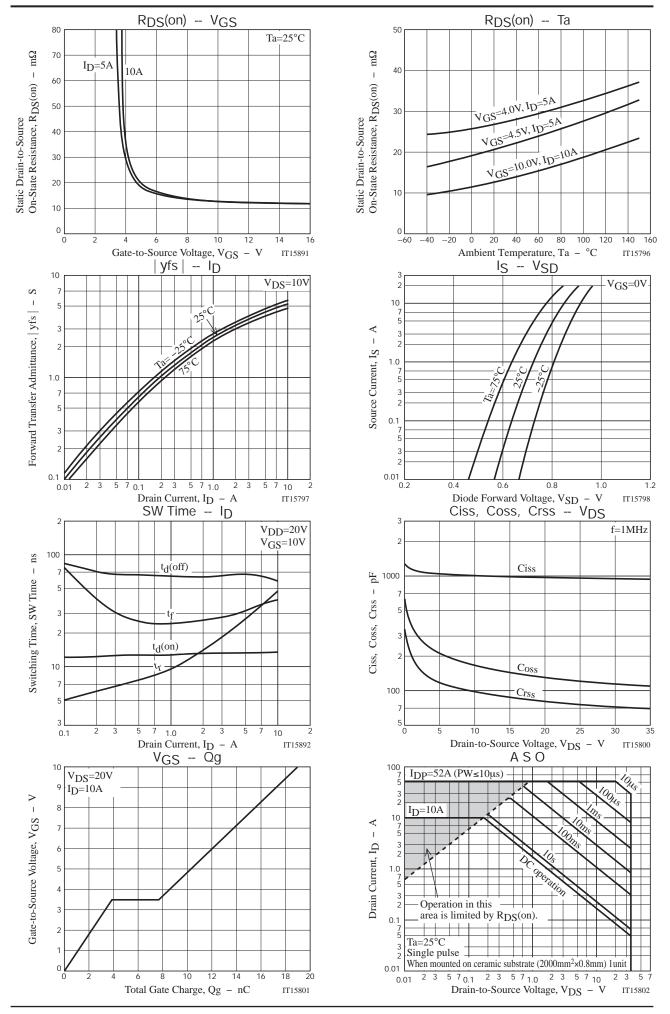
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	35			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =35V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =10A		5.2		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	I _D =10A, V _{GS} =10V		13	17	mΩ
	R _{DS} (on)2	I _D =5A, V _{GS} =4.5V		21	30	mΩ
	R _{DS} (on)3	I _D =5A, V _{GS} =4V		27	38	mΩ
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		960		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		130		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		80		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		13.5		ns
Rise Time	tr	See specified Test Circuit.		46.6		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		57.0		ns
Fall Time	t _f	See specified Test Circuit.		38.9		ns
Total Gate Charge	Qg	V _{DS} =20V, V _{GS} =10V, I _D =10A		19		nC
Gate-to-Source Charge	Qgs	V _{DS} =20V, V _{GS} =10V, I _D =10A		3.9		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =20V, V _{GS} =10V, I _D =10A		3.8		nC
Diode Forward Voltage	V _{SD}	I _S =10A, V _{GS} =0V		0.85	1.2	V

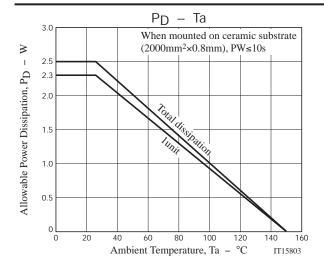
Switching Time Test Circuit

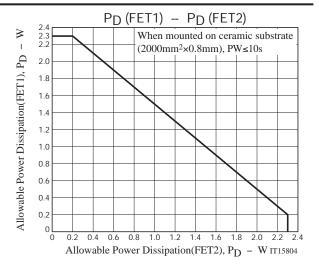












Note on usage: Since the FW812 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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